

## C1812C561JGGAC7210

SMD Comm COG HV, Ceramic, 560 pF, 5%, 2,000 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1812, 2.3 mm



General Information	
Series	SMD Comm COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	67 mg
Shelf Life	78 Weeks
MSL	1

mensions		Sp
nip Size	1812	Ca
	4.5mm +/-0.3mm	Me
	3.2mm +/-0.3mm	Tol
	1.4mm +/-0.15mm	Vo
	2.3mm MIN	Die
	0.6mm +/-0.35mm	Ter
		Tor

## Packaging Specifications Packaging

Dir Ch L W T S B

Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	4000

Specifications	
Capacitance	560 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	2000 VDC
Dielectric Withstanding Voltage	2,400 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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